

**PATENT APPLICATION**  
Attorney's Do. No. 9898-206

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re patent application of: Shin Kim, et al.

Confirmation No. 6784

Serial No. 10/068,628

Filed: February 6, 2002

For: SEMICONDUCTOR DEVICE BONDING PAD RESISTANT TO  
STRESS AND METHOD OF FABRICATING THE SAME

Examiner: Dinh, Tuan T.

Group Art Unit: 2827

**REQUEST FOR CONTINUED EXAMINATION (RCE) TRANSMITTAL**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the  
above-identified application.

**1. Submission required under 37 C.F.R. § 1.114**

a. ☒ Previously submitted:

☒ Consider the amendment(s) reply under 37 C.F.R. § 1.116 previously  
filed on April 28, 2003.

☐ Consider the arguments in the Appeal Brief or Reply Brief previously  
filed on \_\_\_\_\_.

**2. Miscellaneous**

☐ Suspension of action on the above-identified application is requested  
under 37 C.F.R. § 1.103(c) for a period of \_\_\_\_\_ months. (Period of  
suspension shall not exceed 3 months; fee under 37 C.F.R. § 1.17(i)  
required).

☐ Other: